

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ju-II LEE	11/15/1999
Nan-Yi LEE	11/15/1999
RECEIVING PARTY DATA	
Name:	Hyundai Electronics Industries Co., Ltd.
Street Address:	San 136-1, Ami-ri, Bubal-eub, Ichon-shi
City:	Kyoungki-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	467-860
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	6624404
CORRESPONDENCE DATA	
Fax Number:	(312)775-8100
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	mmaslowska@mcandrews-ip.com
Correspondent Name:	McAndrews, Held & Malloy, Ltd.
Address Line 1:	500 W Madison
Address Line 2:	Suite 3400
Address Line 4:	Chicago, ILLINOIS 60661
ATTORNEY DOCKET NUMBER:	21325US02
NAME OF SUBMITTER:	Peter J. McAndrews
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PATENT
REEL: 023401 FRAME: 0651

ASSIGNMENT

In consideration of the receipt of good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) LEE, JU-IL (4) _____
(2) LEE, NAN-YI (5) _____
(3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

HYUNDAI ELECTRONICS INDUSTRIES CO., LTD., a corporation organized under the
laws of the Republic of Korea, located at SAN 136-1, AMI-RI, BUBAL-EUB, ICHON-SHI,
KYOUNGKI-DO, 467-860, KOREA.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled CMOS IMAGE

SENSOR HAVING ENHANCED PHOTOSENSITIVITY AND METHOD FOR FABRICATING
THE SAME

(a) for which an application for United States Letters Patent was filed on _____, and
identified by United States Serial No. _____;
or

(b) for which an application for United States Letters Patent was executed on _____

and the undersigned hereby authorize and request the United States Commissioner of Patent and Trademarks to issue any and all United States Letters Patents which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED of the dates indicated aside our signatures:

<u>INVENTORS</u>	<u>DATE SIGNED</u>
1) <u>[Signature]</u> Name: <u>LEE, JU-IL</u>	<u>Nov. 15, 1999</u>
2) <u>[Signature]</u> Name: <u>LEE, NAN-YI</u>	<u>Nov. 15, 1999</u>
3) _____ Name: _____	_____
4) _____ Name: _____	_____
5) _____ Name: _____	_____
6) _____ Name: _____	_____

RECORDED: 12/30/1999

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RECORDED: 10/21/2009

PATENT
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